

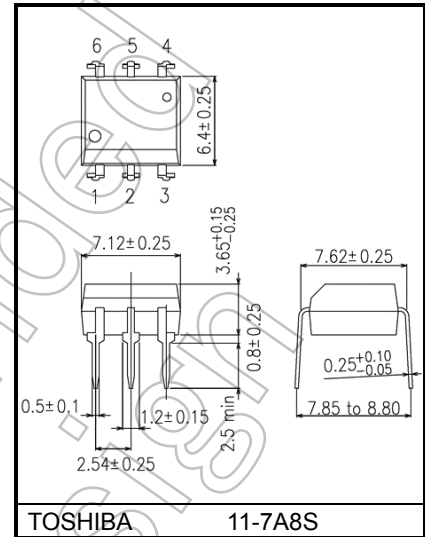
# TLP631, TLP632

Programmable Controllers  
AC/DC-Input Module  
Solid State Relay

The TOSHIBA TLP631 and TLP632 consist of a photo-transistor optically coupled to an infrared emitting diode in a six lead plastic DIP. TLP632 has no-base internal connection for high-EMI environments.

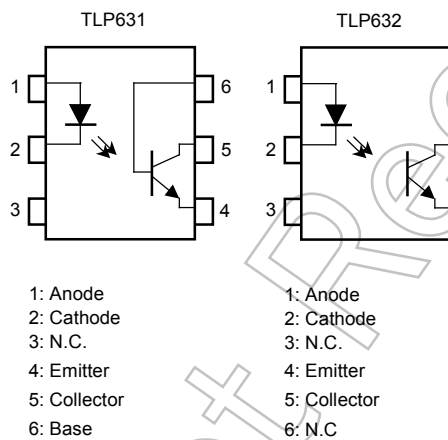
- Collector-emitter voltage: 55 V (min)
- Current transfer ratio: 50% (min)  
Rank GB: 100% (min)
- Isolation voltage: 5000 Vrms (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A  
File No.E67349

Unit: mm



Weight: 0.4 g (typ.)

## Pin Configurations (top view)



Start of commercial production  
1983-05

## Current Transfer Ratio

Classification (Note 1)	Current Transfer Ratio (%) (I <sub>C</sub> /I <sub>F</sub> )		Marking Of Classification
	I <sub>F</sub> = 5 mA, V <sub>CE</sub> = 5 V, T <sub>a</sub> = 25°C		
	Min	Max	
Blank	50	600	Blank, Y <sup>■</sup> , YE, G, G <sup>■</sup> , GR, B, BL, GB
Rank Y	50	150	YE, Y <sup>■</sup>
Rank GR	100	300	GR, G, G <sup>■</sup>
Rank BL	200	600	BL, B
Rank GB	100	600	GB, GR, G, G <sup>■</sup> , BL, B
Rank YH	75	150	Y <sup>■</sup>
Rank GRL	100	200	G
Rank GRH	150	300	G <sup>■</sup>
Rank BLL	200	400	B

Note 1: Ex, rank GB: TLP631 (GB)

Note: Application type name for certification test, please use standard product type name, i. e.

TLP631 (GB): TLP631

TLP632 (GB): TLP632

## Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current	I <sub>F</sub>	60	mA
	Forward current derating (Ta ≥ 39°C)	ΔI <sub>F</sub> /°C	-0.7	mA/°C
	Peak forward current (100 μs pulse, 100 pps)	I <sub>FP</sub>	1	A
	Reverse voltage	V <sub>R</sub>	5	V
	Diode power dissipation	P <sub>D</sub>	70	mW
	Diode power dissipation derating (Ta ≥ 39 °C)	ΔP <sub>D</sub> /°C	-0.82	mW/°C
Detector	Collector-emitter voltage	V <sub>CEO</sub>	55	V
	Collector-base voltage (TLP631)	V <sub>CBO</sub>	80	V
	Emitter-collector voltage	V <sub>ECO</sub>	7	V
	Emitter-base voltage (TLP631)	V <sub>EBO</sub>	7	V
	Collector current	I <sub>C</sub>	50	mA
	Power dissipation	P <sub>C</sub>	150	mW
	Power dissipation derating (Ta ≥ 25°C)	ΔP <sub>C</sub> /°C	-1.5	mW/°C
Storage temperature range		T <sub>stg</sub>	-55 to 125	°C
Operating temperature range		T <sub>opr</sub>	-55 to 100	°C
Lead soldering temperature (10 s)		T <sub>sol</sub>	260	°C
Total package power dissipation		P <sub>T</sub>	250	mW
Total package power dissipation derating (Ta ≥ 25°C)		ΔP <sub>T</sub> /°C	-2.5	mW/°C
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)		BV <sub>S</sub>	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Device considered a two terminal device: LED side pins Shorted together and DETECTOR side pins shorted together.

## Recommended Operating Conditions

Characteristic	Symbol	Min	Typ.	Max	Unit
Supply voltage	V <sub>CC</sub>	—	5	24	V
Forward current	I <sub>F</sub>	—	16	25	mA
Collector current	I <sub>C</sub>	—	1	10	mA
Operating temperature	T <sub>opr</sub>	-25	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

### Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	$V_F$	$I_F = 10 \text{ mA}$	1.0	1.15	1.3	V
	Reverse current	$I_R$	$V_R = 5 \text{ V}$	—	—	10	$\mu\text{A}$
	Capacitance	$C_T$	$V = 0 \text{ V}, f = 1 \text{ MHz}$	—	30	—	pF
Detector	Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C = 0.5 \text{ mA}$	55	—	—	V
	Emitter-collector breakdown voltage	$V_{(BR)ECO}$	$I_E = 0.1 \text{ mA}$	7	—	—	V
	Collector-base breakdown voltage (TLP631)	$V_{(BR)CBO}$	$I_C = 0.1 \text{ mA}$	80	—	—	V
	Emitter-base breakdown voltage (TLP631)	$V_{(BR)EBO}$	$I_E = 0.1 \text{ mA}$	7	—	—	V
	Collector dark current	$I_{CEO}$	$V_{CE} = 24 \text{ V}$	—	10	100	nA
			$V_{CE} = 24 \text{ V}, T_a = 85^\circ\text{C}$	—	2	50	$\mu\text{A}$
	Capacitance collector to emitter	$C_{CE}$	$V = 0 \text{ V}, f = 1 \text{ MHz}$	—	10	—	pF

### Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Current transfer ratio	$I_C/I_F$	$I_F = 5 \text{ mA}, V_{CE} = 5 \text{ V}$ Rank GB	50	—	600	%
			100	—	600	
Saturated CTR	$I_C/I_F(\text{sat})$	$I_F = 1 \text{ mA}, V_{CE} = 0.4 \text{ V}$ Rank GB	—	60	—	%
			30	—	—	
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$	$I_C = 2.4 \text{ mA}, I_F = 8 \text{ mA}$	—	—	0.4	V

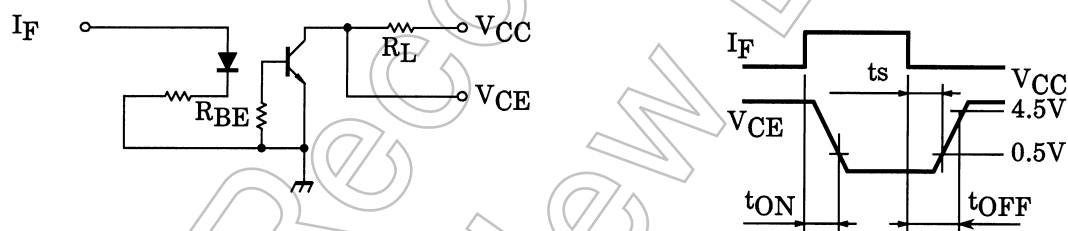
### Isolation Characteristics (Ta = 25°C)

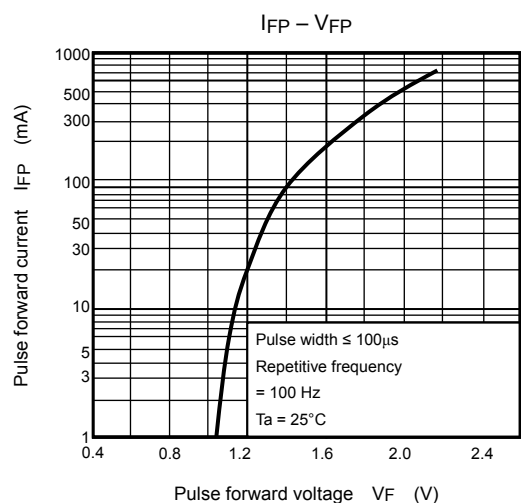
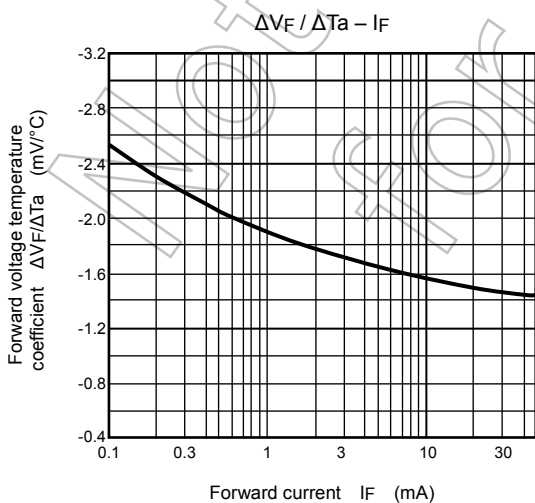
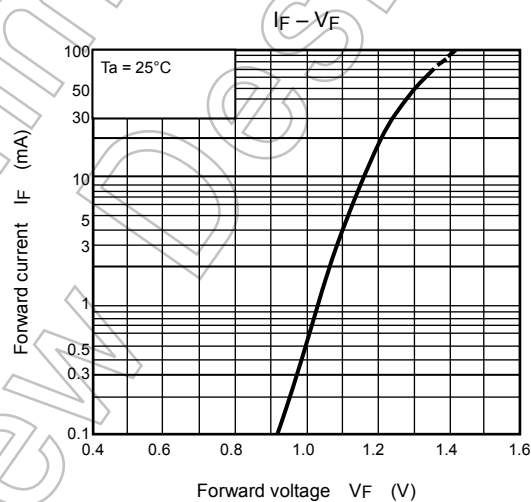
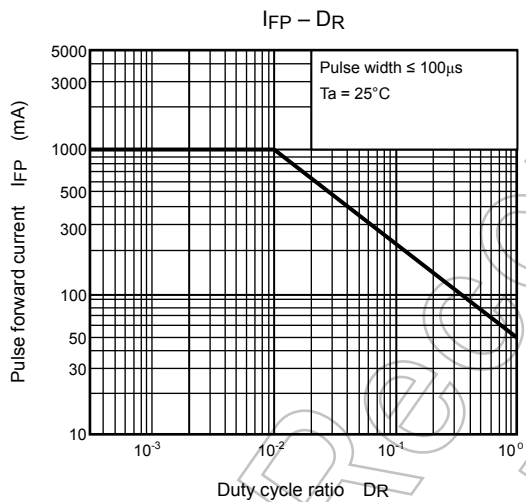
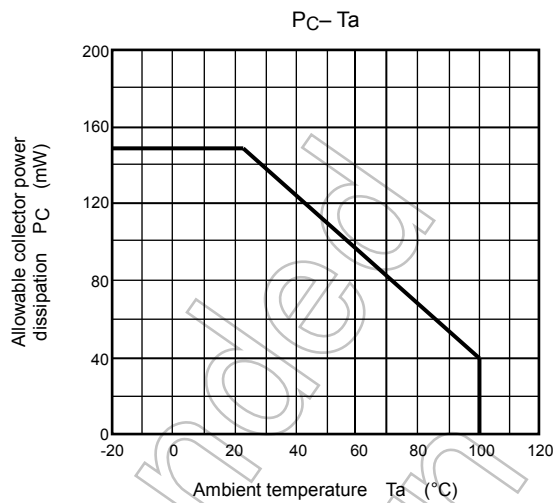
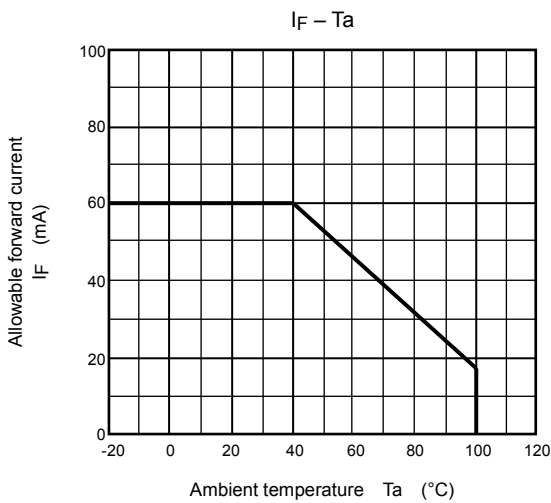
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance (input to output)	C <sub>S</sub>	V <sub>S</sub> = 0 V, f = 1 MHz	—	0.8	—	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5×10 <sup>10</sup>	10 <sup>14</sup>	—	Ω
Isolation voltage	BV <sub>S</sub>	AC, 60 s	5000	—	—	Vrms

### Switching Characteristics (Ta = 25°C)

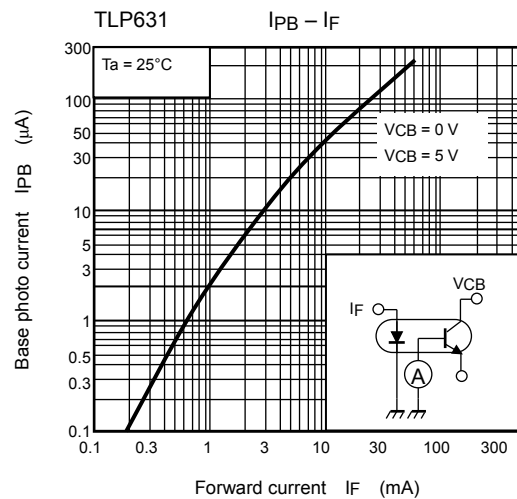
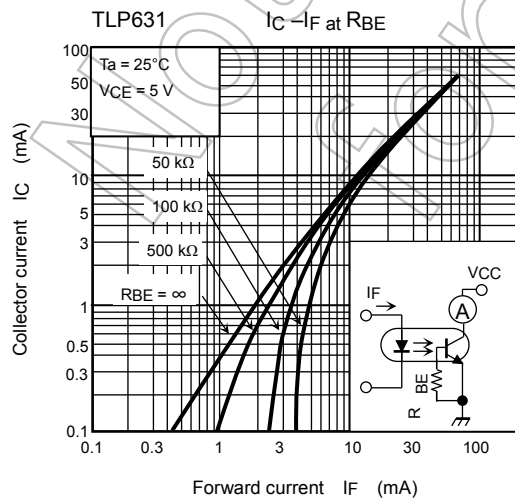
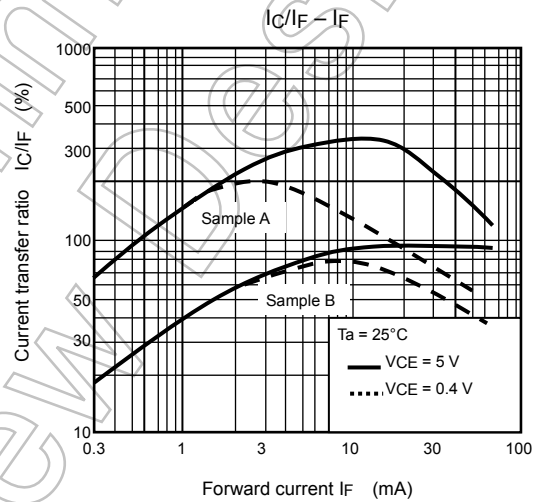
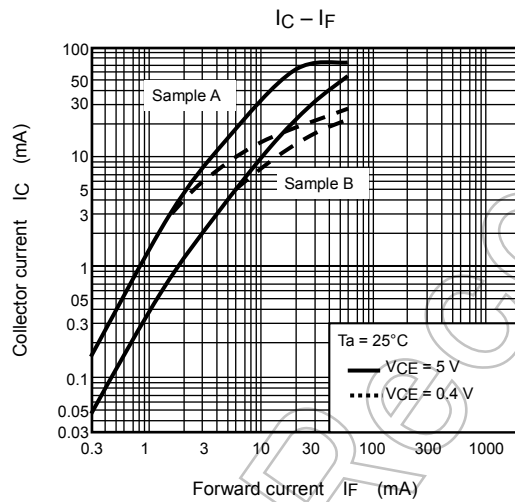
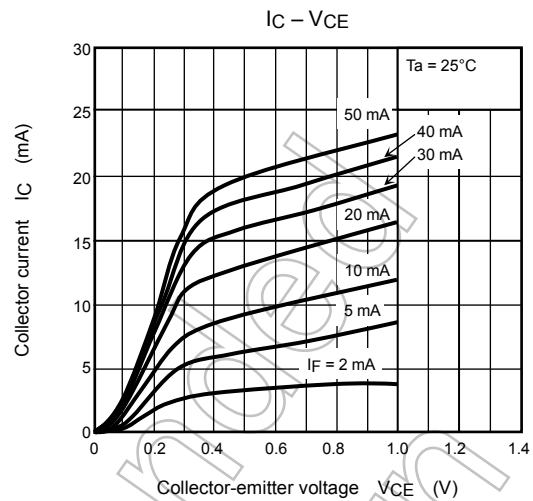
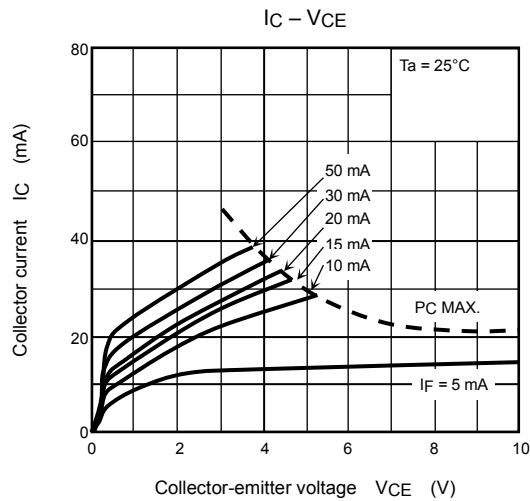
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Rise time	t <sub>r</sub>	V <sub>CC</sub> = 10 V, I <sub>C</sub> = 2 mA R <sub>L</sub> = 100 Ω	—	2	—	μs
Fall time	t <sub>f</sub>		—	3	—	
Turn-on time	t <sub>on</sub>		—	3	—	
Turn-off time	t <sub>off</sub>		—	3	—	
Turn-on time	t <sub>ON</sub>	R <sub>L</sub> = 1.9 kΩ (Fig.1) R <sub>BE</sub> = OPEN V <sub>CC</sub> = 5 V, I <sub>F</sub> = 16 mA	—	2	—	μs
Storage time	t <sub>s</sub>		—	15	—	
Turn-off time	t <sub>OFF</sub>		—	25	—	
Turn-on time	t <sub>ON</sub>	R <sub>L</sub> = 1.9 kΩ (Fig.1) R <sub>BE</sub> = 220 kΩ (TLP631) V <sub>CC</sub> = 5 V, I <sub>F</sub> = 16 mA	—	2	—	μs
Storage time	t <sub>s</sub>		—	12	—	
Turn-off time	t <sub>OFF</sub>		—	20	—	

Fig. 1 Switching time test circuit

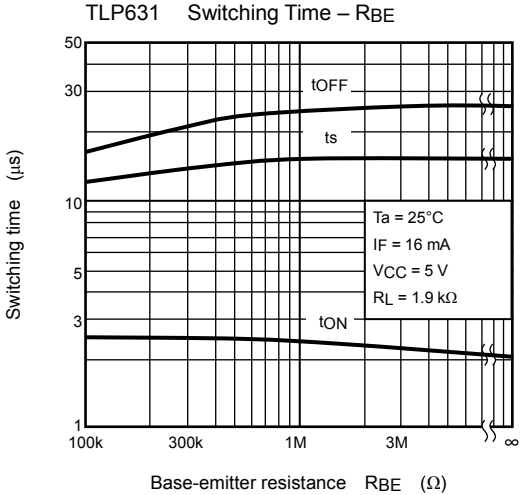
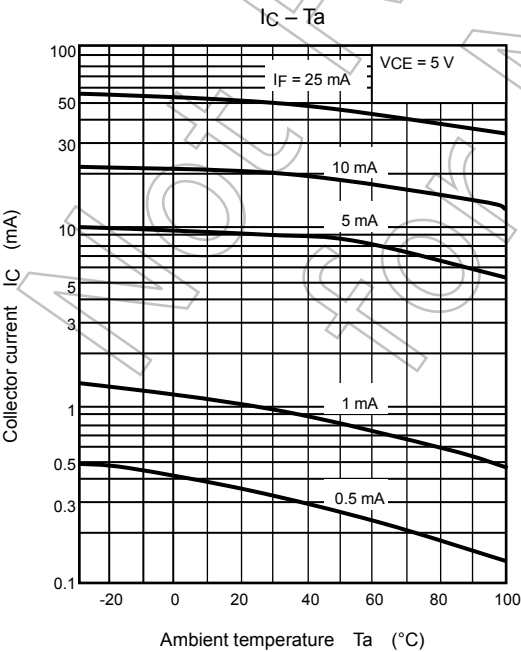
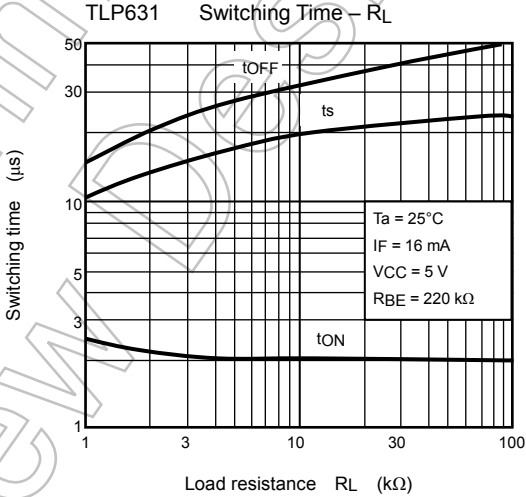
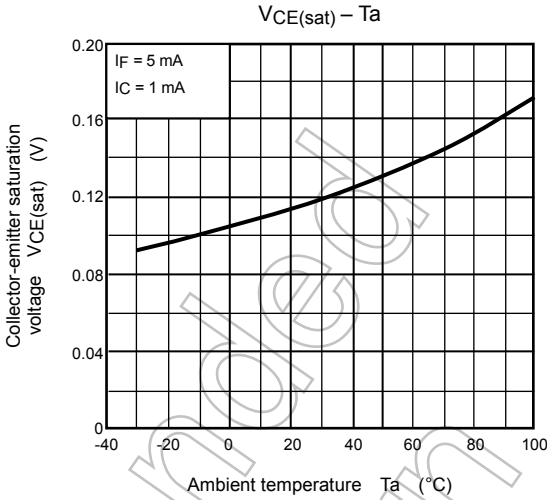
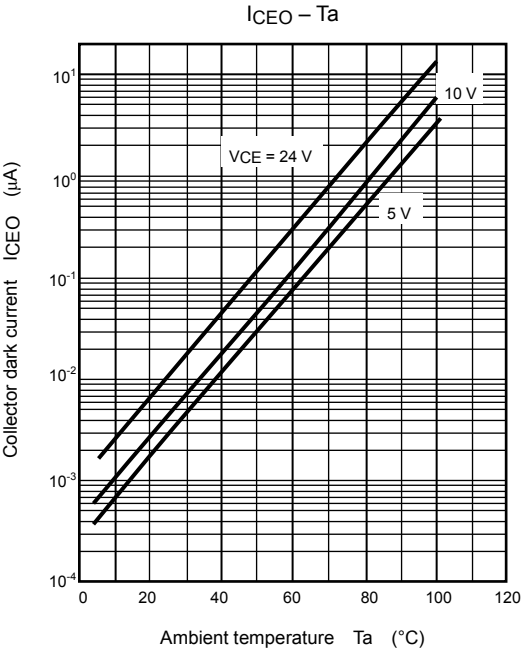




NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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